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To the Honorable Commissioner of Patents and Trademarks, please return the attached original documents or copy thereof.

1. Name of conveying party(ies):  
Jie-Wei Chen and Adolf Niederberger  
  
08-16-02  
Additional name(s) of conveying party(ies) attached?  Yes  No

2. Name and address of receiving party(ies)  
Name: Leister Process Technologies  
Internal Address: Riedstrasse, CH-6050  
Sarnen, Switzerland  
  
Street Address: \_\_\_\_\_  
  
City: \_\_\_\_\_ State: \_\_\_\_\_ Zip: \_\_\_\_\_  
Additional name(s) & address(es) attached?  Yes  No

3. Nature of conveyance:  
 Assignment  Merger  
 Security Agreement  Change of Name  
 Other \_\_\_\_\_  
  
Execution Date: July 15, 2002

4. Application number(s) or patent number(s):  
If this document is being filed together with a new application, the execution date of the application is: \_\_\_\_\_  
A. Patent Application No.(s)  
10/172,537  
Additional numbers attached?  Yes  No

B. Patent No.(s)  
\_\_\_\_\_

5. Name and address of party to whom correspondence concerning document should be mailed:  
Name: Gregory P. LaPointe  
Internal Address: Bachman & LaPointe, P.C.  
Suite 1201  
  
Street Address: 900 Chapel Street  
  
City: New Haven State: CT Zip: 06510

6. Total number of applications and patents involved: 1  
7. Total fee (37 CFR 3.41).....\$ 40.00  
 Enclosed  
 Authorized to be charged to deposit account  
8. Deposit account number:  
02-0184  
(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.  
*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*  
Gregory P. LaPointe [Signature] August 7, 2002  
Name of Person Signing Signature Date

Total number of pages including cover sheet, attachments, and documents: 2

# Assignment

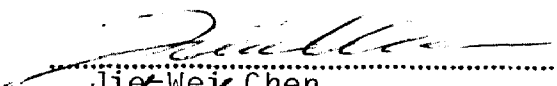

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned, Jie-Wei Chen and Adolf Niederberger,

Hereby sell, assign and transfer to  
Leister Process Technologies

a corporation of Switzerland  
having a place of business at Riedstrasse, CH-6060 Sarnen, Switzerland,  
its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith  
and is entitled PROCESS AND APPARATUS FOR JOINING POLYMER MATERIAL AT A HIGH WELDING SPEED (Attorney's Docket No. 02-414 (SN 10/172,537, Filed June 13, 2002)), and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date..... 15.07.02 .....	 .....(L.S.)
Date..... 15.07.02 .....	 .....(L.S.)
Date..... .....	.....(L.S.)
Date..... .....	.....(L.S.)